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MPD and SPD for NICA project Questions and Answers

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The CBM experiment at FAIR





The CBM experiment at FAIR



CBM Silicon Tracking System (STS)

- CBM's central detector system
- largest detector project at GSI for FAIR
 - 8 high-tech tracking stations
 - 2 m³ volume in dipole magnet
 - 2.5 M channels, 40 kW dissipation
 - 10 MHz event rate, 1 TB/s data



- International project:
 - 14 CBM member institutes from Germany, Russia, Poland, Ukraine
 - GSI has project leadership
 - partner project at JINR (BM@N)



NICA megaproject



MPD detector at NICA

Magnet : 0.5 T T0, Trigger : FFD Centrality & Event plane : ZDC Tracking (|η|<2): TPC PID: TOF, TPC, ECAL



Stage 1 (2017) TPC, Barrel TOF & ECAL, ZDC, FFD Stage 2: IT + Endcaps(tracker,TOF,ECAL)



MPD ITS status



Invariant mass spectrum for lambdas in Au+Au at 7 GeV z 350 - Data Real hitproducer Background fit P = 2.75300 Signal fit N/S = 5.39 **Global Fit** 250 200 150 100 50 1.07 1.08 1.09 1.1 1.11 1.12 1.13 1.14 1.15 1.16 1.17 Mass, Gev



Computer model simulations by V.P.Kondratiev and N.Prokofiev, SPbSU together with A.I.Zinchenko and V.A.Vasendina

BM@N Silicon Tracking System



The CBM experiment at FAIR



STS design constraints

• Coverage:

- rapitidies from center-of mass to close to beam
- aperture $2.5^{\circ} < \Theta < 25^{\circ}$ (less for BM_N)

Momentum resolution

- $\delta p/p \cong 1\%$
- field integral 1 Tm, 8 tracking stations
- 25 µm single-hit spatial resolution
- material budget per station ~1% X_0

No event pile-up

- 10 MHz interaction rates
- self-triggering read-out
- signal shaping time < 20 ns

Efficient hit & track reconstruction

- close to 100% hit eff.
- > 95% track eff. for momenta >1 GeV/c

Minimum granularity

@ hit rates < 20 MHz/cm²

- maximum strip length compatible with hit occupancy and S/N performance
- largest read-out pitch compatible with the required spatial resolution

Radiation hard sensors

compatible with the CBM physics program

- $-1 \times 10^{13} n_{eq}/cm^2$ (SIS100)
- $-1 \times 10^{14} n_{eq}/cm^2$ (SIS300)

• Integration, operation, maintenance

 compatible with the confined space in the dipole magnet

STS concept

- Aperture: $2.5^{\circ} < \Theta < 25^{\circ}$ (some stations up to 38°).
- 8 tracking stations between 0.3 m and 1 m downstream the target.
- Built from double-sided silicon microstrip sensors in 3 sizes, arranged in modules on a small number of different detector ladders.
- Readout electronics outside of the physics aperture.



Microstrip sensors

- double-sided, p-n-n structure
- width: 6.2 cm
- 1024 strips at 58 μm pitch
- three types, strip lengths: 2, 4, 6 cm, 4 cm
- stereo angle front-back-sides 7.5°
- integrated AC-coupled read-out
- double metal interconnects on p-side, or replacement with an external micro cable
- operation voltage up to few hundred volts
- radiation hardness up to $1 \times 10^{14} n_{eq}/cm^2$

4" and 6" wafers, 300 µm thick test and full-size sensors



Assessment of tracking stations - material budget

station 4



Assessment of tracking stations - sensor occupancy

sensor occupancy := *ratio* "*nb. of hit strips : nb . of all strips*" *in a sensor*



Assessment of tracking stations - hit cluster size

cluster of strips := number of adjacent strips in a sensor that fire simultaneously

distribution for full STS

in station 4



Track reconstruction performance studies



track reconstruction efficiency

momentum resolution



- \Rightarrow Ongoing layout improvements:
- aperture improvements to be done in some of the stations: better coverage around beam pipe
- optimize number and type of modules and their deployment in the stations

Modern fast and high precision instrumentation based on microstrip sensors







Supermodule ("the ladder")= Sensitive modules on light weighed CF support frames with FEE in cooled containers at the rare ends

The CBM-MPD STS Consortium Since Nov 2008 till 2013



CBM-MPD STS Consortium

- 8 institutes
- 5 countries

CBM in
 Darmstadt

MPD and BM@N in Dubna

- GSI, Darmstadt, Germany
- JINR, Dubna, Russia
- IHEP, Protvino, Russia
- MSU, Moscow, Russia
- KRI, St.Petersburg, Russia
- SPbSU, St.Petersburg
- SE SRTIIE, Kharkov, Ukraine
- NCPHEP, Minck, Belarus Rep.
- PI AS, Prague, Czech Rep
- Components
- Sensors
- Modules assembly
- Ladder assembly
- Radiation tests
- In-beam tests



STS (BM@N / ITS)



Components Readiness: The sensors

Prototype	Year	Vendor	Processing	Size [cm ²]	Description
CBM01	2007	CiS	double-sided	5.5×5.5	±7.5 deg
CBM03	2010	CiS	double-sided	6.2×6.2	±7.5 deg
CBM03'	2011	CiS	Single/CBM03	6.2×6.2	test for CBM05
CBM05	2013	CiS	double-sided	6.2 × 6.2	7.5/0 deg full-size
CBM05H4	2013	Hamamatsu for GSI	double-sided	6.2×4.2	7.5/0 deg full-size
CBM05H2	2013	Hamamatsu for JINR	single-sided	6.2 × 2.2	7.5/0 deg full-size



under study: replacement for integrated 2nd metal layer

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external on-sensor cable

Components Readiness: The Cables

Components type	Q-ty for STS (+20%), pcs	Material	View
Analog connecting layer	34400	FDI-A-24	
Meshed spacer	38700	Polyimide	
Shielding layer	2150	FDI-A-24	
Daisy –chain cable	778	FDI-A-20 (24)	
Interstrip cable	1464	FDI-A-24	

Components Readiness: Readout ASIC

full-size prototype dedicated to signal detection from the doublesided microstrip sensors in the CBM environment

fast \Leftrightarrow low noise \Leftrightarrow low power dissipation

new w.r.t. n-XYTER architecture: effective two-level discriminator scheme

design V1.0 @ AGH Kraków UMC 180 nm CMOS

produced 2012 die size 6.5 mm × 10 mm second round planned forfall 2014

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Channels, pitch	128 + 2 test
Channel pitch	58
Input signal polarity	+ and -
Input current	10 nA
Noise at 30 pF load	900 e ⁻
ADC range	16 fC, 5 bit
Clock	250 MHz
Power dissipation	< 10 mW/channel
Timestamp resolution	< 10 ns
output interface	4 × 500 Mbit/s LVDS

STS module concept



Detector module composition



Technological scheme of single-sensor module assembly

26



Technological scheme of chip with analogue cable assembling

27





Technological scheme of analogue cables with sensor assembling



CF Mechanics Readiness :Punch@Mould Produced in SPb with ten CF space frames manufactured @ CERN









Punch and Mold for production of true CBM supporting frames

Demonstrators and prototypes







Prototype Device for ladder assembling manufactured at PLANAR, Minsk , Rep. of Belarus, 2012



Preparations for the in-beam tests at Nuclotron

•Equipment of JINR test bench with n-XYTER readout



 Mechanics preparation
 Slow Control for Protvino in-beam
 Logic Init for recording the external DAQ
 information into the ROC



Status: Preparations for the in-beam tests at Nuclotron

Timelines of CBM STS

- 1) STS Technischer Design Report (approved 8/2013)
- 2) Pre-production phase (2014): Technology decisions,
- module demonstrators
- 3) Production Readiness Review (7/2015)
- 4) Series production of sensors until ~ mid 2017:
- 5) STS commissioning (2018)



LHEP JINR STS-BM@N-ITS Effort Strategic Plan



STS and ITS FEE

CBM-xyter
Self triggering
High power consumption
Too fast
Not ready yet
5-bit ADC

Tentative Work Plan for 2014-15



37

The Conclusions

>Through years 2008-2013 the CBM-MPD STS Consortium has accomplished 80-90% of R&D activity which could be successfully accomplished by mid 2015 > In 2013 not only the targets but additional sources of budgeting of the common GSI-JINR project were indicated: GSI-JINR LHEP STS assembling Lab MoU signed with resources + draft of the FAIR-JINR-ROSATOM -CBM Contract for assembling four stations of CBM STS at LHEP is ready for signatures > To resolve the "manpower crises" administrative decision have been taken to organize a department of STS for CBM, BM@N and ITS

>All young researchers are be in a joint working group which will built the core of team to yield the benefit of the STS being used at Nuclotron and NICA

Questions

Difference between MPD and SPD Inner Tracking System:

- Single hit resolution
- Tracking resolution
- Tracking efficiency
- Secondary vertex resolution
- Momentum resolution
- Material budget

Thank you for your attention!

Thanks for courtesy of using the slides to J.Heuser, M.Protsenko,I.Tymchuk